	CONNECTING CS INDUSTRIES® International and Part	PC, Bannockb	ourn, Illinois. A	ll rights reserved u ntions.	nder both	This docume level parts, t	ent is a declarat	ion of the encompas	e substances sses all lowe	within the er level mate	manufacture erials for wh	er listed it hich the m	em. Note: anufacture	if the item is an as er has engineering	ssembly with lowe responsibility.
1752-21.1	IPC Web Site for Information on IPC-1752 Standard Form Typ http://www.ipc.org/IPC-175x Distribute				* Declaration Class * Class 6 - RoHS Yes/No, Homogeneous Mater					ous Materia	als and Mfg Information				
Supplier	r Information														
Company	name*	Company unique ID				Unique ID Authority					Response Date*				
nsemi											2023-06-08				
Contact N	lame	Title - Contact				Phone - Contact*				Email - Contact*					
Product-I	Env-Stewards	Product Enviro Compliance				NA					Product-Env-Stewards@onsemi.com				
uthorize	ed Representative*	Title - Representative				Phone - Representative*				Email - Representative*					
Product-I	Env-Stewards	Product Enviro Compliance				NA				Product-Env-Stewards@onsemi.com					
	Requester Item Number Mfr Item Number   DFB2080		Number Mfr Item Name				Effective Date	ve Date Version Manufacturing Sit		ing Site	1	Weight*	UOM	Unit Type	
			0	BR TS6P GPPN 20A 800V			2023-06-08 TSCBE			7671.0		mg	Each		
/anufa	cturing Proccess Informat	tion													L
	Terminal Plating / Grid Array Material		Ferminal Base Alloy J-STD-020 M		J-STD-020 MS	L Rating	Peak Process Body Temper		y Temperatu	ture Max Time at Peak T		Temperat	ure Num	ber of Reflow Cy	cles
	Matte Tin (Sn) - annealed		U Alloy NA			<b>0</b> C		C	30		secon	ds 3			
Comments	3														
or more	information regarding material	composition	please refer to	page 3											

RoHS Material Composition Declaration				Declaration Type *	Detailed					
Directive 2015/863/EU amending RoHS Directive 2011/65/EU		mium (Cr6+), Polybrominated Biphenyls (Pl		dmium and quantity limit of 0.1% by mass (10 minated Diphenyl Ethers (PBDE), and Bis(2-et						
cadmium, hexavalentchromium, polybromina contains a RoHS restricted substance inexces encompass all such components. Supplier cer as of the date that Supplier completes this for Company acknowledges that Supplier may h independently verified information provided certification in this paragraph. If the Company	ated biphenyls and/or polybrominated dip s of an applicable quantity limit, please in iffies that it gathered the information it pr m.Supplier acknowledges that Company ave relied on informationprovided by oth by others, Supplier agrees that, at a minir and the Supplier enter into a written agr esource of the Supplier's liability and the	henyl ethers (each a "RoHS restricted substa ndicate below which, if any, RoHS exemption ovides in this form using appropriate methoo will rely on this certification in determining ers in completing this form, and that Supplie num, itssuppliers have provided certification eement with respect to the identified part, the Company's remedies for issues that arise reg	nce") in exco n you believe ls to ensure i the compliar r may not ha s regarding t terms and co	e may apply. If the part is an assembly with low s accuracy and that such information is true an ce of its products with European Union member de independently verified such information. Ho neir contributions to the part, and those certifica	ove. If a homogeneous material within the part er level components, the declaration shall d correct to the best of its knowledge and belief, er state laws that implement the RoHS Directive. wever, in situations where Supplier has not ations are at least as comprehensive as the anty rights and/or remedies provided as part of					
RoHS Declaration * 4 - Item(	s) does not contain RoHS restricted subst	ances per the definition above except for sele	ected exempt	ions Supplier Acceptance	* Accepted					
Exemption: 7a: Lead in high melting temperature type solders (i.e. lead based solder alloys containing 85% by weight or more lead).										
Exemption List Version	EL-2011/534/EU									
Declaration Signature										
Instructions: Complete all of the required fields on all pages of this form. Select the "Accepted" on the Supplier Acceptance drop-down. This will display the signature area. Digitally sign the declaration (if required by the Requester) and click on Submit Form to have the form returned to the Requester.										
Supplier Digital Signature	astislav Drska	Le								

## Homogeneous Material Composition Declaration for Electronic Products

SubItem Instructions: The presence of any JIG Level A or B substances must be declared. [1] indicate the subpart in which the substance is located, [2] provide a description of the homogeneous material [3], enter the weight of the homogeneous material.

Homogeneous Material	Weight	Unit of Measure	Level	Substance	CAS	Exempt	Weight	Unit of Measure
Die Attach Solder	200.0	mg	Supplier	Silver (Ag)	7440-22-4		5	mg
			А	Lead (Pb)	7439-92-1	7a	185	mg
			Supplier	Tin (Sn)	7440-31-5		10	mg
umper	60.4	mg	Supplier	Iron (Fe)	7439-89-6		0.05	mg
			Supplier	Copper (Cu)	7440-50-8		60.34	mg
			Supplier	Phosphorus (P)	7723-14-0		0.01	mg
Lead Frame	2315.0	mg	Supplier	Iron (Fe)	7439-89-6		1.852	mg
			Supplier	Copper (Cu)	7440-50-8		2312.6851	mg
			Supplier	Phosphorus (P)	7723-14-0		0.463	mg
Mold Compound-Black	4807.0	mg	В	Brominated Bisphenol A Diglycidyl Ether	40039-93-8		96.14	mg
			Supplier	Ortho Cresol Novolac Resin	29690-82-2		721.05	mg
			В	Antimony Trioxide (Sb2O3)	1309-64-4		96.14	mg
			Supplier	Carbon Black (C)	1333-86-4		48.07	mg
			Supplier	Phenolic Resin (Novolac)	9003-35-4		480.7	mg
			Supplier	Silica Crystalline (SiO2)	14808-60-7		3364.8999	mg
Plating	248.6	mg	Supplier	Tin (Sn)	7440-31-5		248.6	mg
Silicon Dice	40.0	mg	Supplier	Silicon (Si)	7440-21-3		39.992	mg
			В	Nickel (Ni)	7440-02-0		0.004	mg
			Supplier	Gold (Au)	7440-57-5		0.004	mg